

UNISONIC TECHNOLOGIES CO., LTD

6N60K-MT **Power MOSFET**

6.2A, 600V N-CHANNEL POWER MOSFET

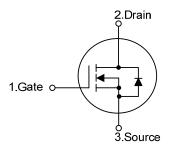
DESCRIPTION

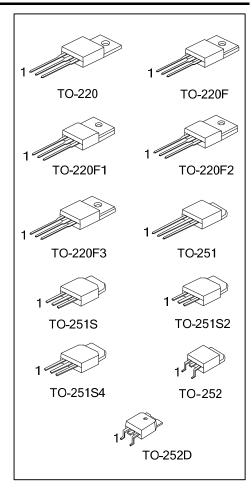
The UTC 6N60K-MT is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 1.40 @ V_{GS} = 10V, I_{D} = 3.1A
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL





Canny Flying 1688.com

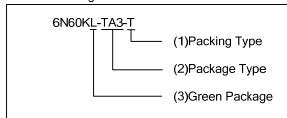
www.unisonic.com.tw

6N60K-MT **Power MOSFET**

ORDERING INFORMATION

| Ordering Number | | Dookago | Pin Assignment | | | Dooking | |
|-----------------|---------------|----------|----------------|---|---|-----------|--|
| Lead Free | Halogen Free | Package | 1 | 2 | 3 | Packing | |
| 6N60KL-TA3-T | 6N60KG-TA3-T | TO-220 | G | D | S | Tube | |
| 6N60KL-TF3-T | 6N60KG-TF3-T | TO-220F | G | D | S | Tube | |
| 6N60KL-TF1-T | 6N60KG-TF1-T | TO-220F1 | G | D | S | Tube | |
| 6N60KL-TF2-T | 6N60KG-TF2-T | TO-220F2 | G | D | S | Tube | |
| 6N60KL-TF3-T | 6N60KG-TF3-T | TO-220F3 | G | D | S | Tube | |
| 6N60KL-TM3-T | 6N60KG-TM3-T | TO-251 | G | D | S | Tube | |
| 6N60KL-TMS-T | 6N60KG-TMS-T | TO-251S | G | D | S | Tube | |
| 6N60KL-TMS2-T | 6N60KG-TMS2-T | TO-251S2 | G | D | S | Tube | |
| 6N60KL-TMS4-T | 6N60KG-TMS4-T | TO-251S4 | G | D | S | Tube | |
| 6N60KL-TN3-R | 6N60KG-TN3-R | TO-252 | G | D | S | Tape Reel | |
| 6N60KL-TND-R | 6N60KG-TND-R | TO-252D | G | D | S | Tape Reel | |

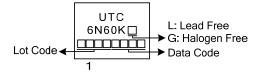
Note: Pin Assignment: G: Gate D: Drain S: Source



- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F3, TM3: TO-251 TMS: TO-251S, TMS2: TO-251S2,

TMS4: TO-251S4, TN3: TO-252, TND: TO-252D (3) L: Lead Free, G: Halogen Free and Lead Free

MARKING





■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

| PARAMETER | | SYMBOL | RATINGS | UNIT |
|------------------------------------|---|------------------|----------------------|------|
| Drain-Source Voltage | | V_{DSS} | 600 | V |
| Gate-Source Voltage | | V_{GSS} | ±30 | V |
| Avalanche Current (Note 2) | | I _{AR} | 6.2 | Α |
| Continuous Drain Current | | I _D | 6.2 | Α |
| Pulsed Drain Current (Note 2) | | I _{DM} | I _{DM} 24.8 | |
| Avalanche Energy | Single Pulsed (Note 3) | E _{AS} | 330 | mJ |
| | Repetitive (Note 2) | | | mJ |
| Peak Diode Recovery dv/dt (Note 4) | | dv/dt | 3.0 | V/ns |
| Power Dissipation | TO-220 | | 125 | W |
| | TO-220F/TO-220F1 TO-220F3 | | 40 | W |
| | TO-220F2 | P _D | 42 | W |
| | TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D | | 55 | W |
| Junction Temperature | | TJ | +150 | °C |
| Operating Temperature | | T _{OPR} | -55 ~ +150 | °C |
| Storage Temperature | | T _{STG} | -55 ~ +150 | °C |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by T_J
- 3. L = 18.33mH, I_{AS} = 6A, V_{DD} = 90V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 6.2A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

| PARAMETER | | SYMBOL | RATINGS | UNIT | |
|---------------------|---|-----------------|---------|------|--|
| Junction to Ambient | TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3 | 0 | 62.5 | °C/W | |
| | TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D | $	heta_{ m JA}$ | 110 | °C/W | |
| Junction to Case | TO-220 | | 1.0 | °C/W | |
| | TO-220F/TO-220F1 TO-220F3 | | 3.2 | °C/W | |
| | TO-220F2 | θ_{JC} | 2.97 | °C/W | |
| | TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D | | 2.27 | °C/W | |



ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

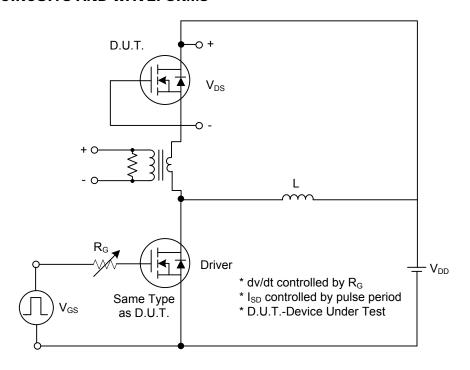
| PARAMETER | | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|------------------|--------------------------------------|---|-----|------|------|------|
| OFF CHARACTERISTICS | | | | • | | | |
| Drain-Source Breakdown Voltage | | BV _{DSS} | V _{GS} =0V, I _D =250μA | 600 | | | V |
| Drain-Source Leakage Current | | I _{DSS} | V _{DS} =600V, V _{GS} =0V | | | 10 | μΑ |
| | | | V _{DS} =480V, V _{GS} =0V, T _J =125°C | | | 10 | μΑ |
| Gate- Source Leakage Current | Forward | I _{GSS} | V _G =30V, V _{DS} =0V | | | 100 | nA |
| | Reverse | | V _{GS} =-30V, V _{DS} =0V | | | -100 | nA |
| Breakdown Voltage Temperature Coefficient | | $\triangle BV_{DSS}/\triangle T_{J}$ | I _D =250μA, Referenced to 25°C | | 0.53 | | V/°C |
| ON CHARACTERISTICS | | | | | | | |
| Gate Threshold Voltage | | $V_{GS(TH)}$ | $V_{DS}=V_{GS}$, $I_D=250\mu A$ | 2.0 | | 4.0 | V |
| Static Drain-Source On-State Resistance | | R _{DS(ON)} | V _{GS} =10V, I _D =3.1A | | | 1.4 | Ω |
| DYNAMIC CHARACTERISTICS | | | | | | | |
| Input Capacitance | nput Capacitance | | | | 540 | | pF |
| Output Capacitance | | Coss | V _{DS} =25V, V _{GS} =0V, f=1.0 MHz | | 97 | | pF |
| Reverse Transfer Capacitance | | C_{RSS} | | | 11 | | pF |
| SWITCHING CHARACTERISTICS | 3 | | | | | | |
| Total Gate Charge | | Q_G | V _{DS} =50V, I _D =1.3A, V _{GS} =10V | | 23 | | nC |
| Gate-Source Charge | | Q_GS | (Note 1, 2) | | 6.7 | | nC |
| Gate-Drain Charge | | Q_GD | (14010-1, 2) | | 5.7 | | nC |
| Turn-On Delay Time | | t _{D(ON)} | | | 60 | | ns |
| Turn-On Rise Time | | t _R | V_{DD} =30V, I_{D} =0.5A, R_{G} =25 Ω | | 66 | | ns |
| Turn-Off Delay Time | | t _{D(OFF)} | (Note 1, 2) | | 120 | | ns |
| Turn-Off Fall Time | | t _F | | | 64 | | ns |
| DRAIN-SOURCE DIODE CHARA | CTERISTIC | S AND MAXII | MUM RATINGS | • | | | |
| Maximum Continuous Drain-Source Diode Forward Current | | Is | | | | 6.2 | Α |
| | | | | | | 0.2 | |
| Maximum Pulsed Drain-Source Diode | | I_{SM} | | | | 24.8 | Α |
| Forward Current | | | | | | | |
| Drain-Source Diode Forward Voltage | | V _{SD} | I _S =6.2A, V _{GS} =0V | | | 1.4 | V |
| Body Diode Reverse Recovery Time | | t _{RR} | | | 400 | | ns |
| Body Diode Reverse Recovery Charge | | Q_{RR} | | | 2.8 | | nC |

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

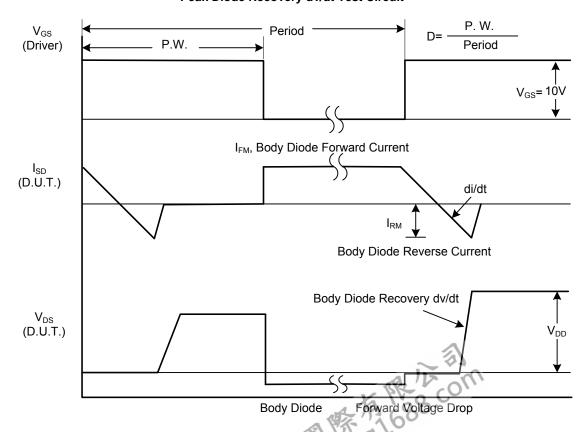
2. Essentially independent of operating temperature.



■ TEST CIRCUITS AND WAVEFORMS



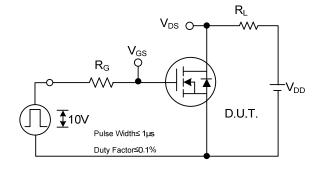
Peak Diode Recovery dv/dt Test Circuit

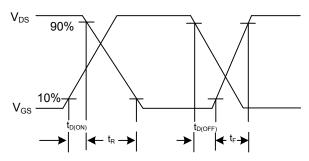


Peak Diode Recovery dv/dt Waveforms

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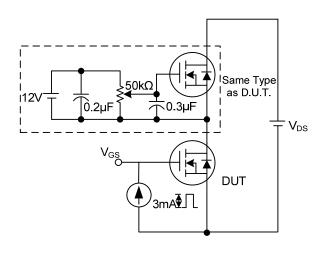
TEST CIRCUITS AND WAVEFORMS (Cont.)

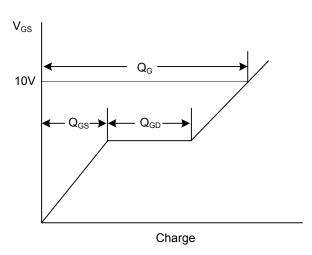




Switching Test Circuit

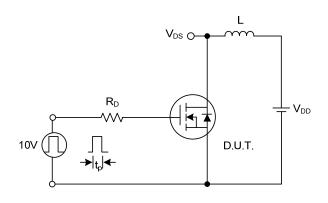
Switching Waveforms

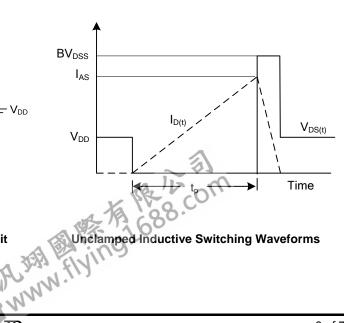




Gate Charge Test Circuit

Gate Charge Waveform

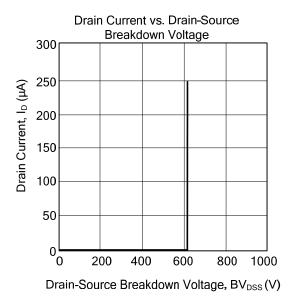


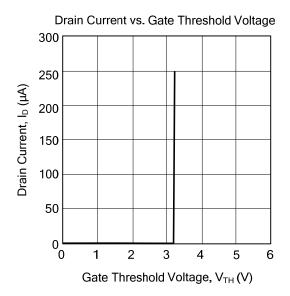


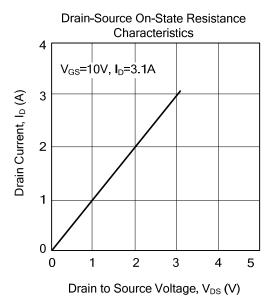
Unclamped Inductive Switching Test Circuit

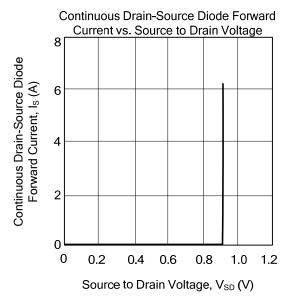
6N60K-MT Power MOSFET

■ TYPICAL CHARACTERISTICS









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